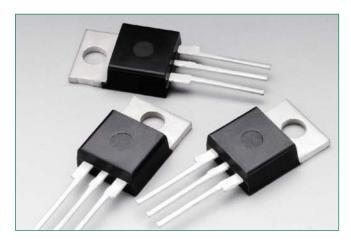
MAC15 Series TRIAC - 400V - 800V







Additional Information







Accessories



Samples

Functional Diagram



Description

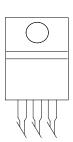
Designed primarily for full-wave ac control applications, such as solid-state relays, motor controls, heating controls and power supplies; or wherever full-wave silicon gate controlled solid-state devices are needed. Triac type thyristors switch from a blocking to a conducting state for either polarity of applied main terminal voltage with positive or negative gate triggering.

Features

- Blocking Voltage to 800 V
- All Diffused and Glass
 Passivated Junctions for
 Greater Parameter Uniformity
 and Stability
- Small, Rugged, Thermowatt Construction for Low Thermal Resistance, High Heat Dissipation and Durability
- Gate Triggering Guaranteed in Three Modes (MAC15 Series) or Four Modes (MAC15A Series)
- These Devices are Pb-Free and are RoHS Compliant

Pin Out





Maximum Ratings (TJ = 25°C unless otherwise noted)

| Rating | Symbol | Value | Unit | |
|--|--|--|-------------------|-------|
| Peak Repetitive Off-State Voltage (Note 1) (Gate Open, Sine Wave 50 to 60 Hz, T _J = -40° to 125°C) | MAC15A6G MAC15-8G, MAC15A8G MAC15-10G, MAC15A10G | V _{DRM} , V _{RRM} | 400 600 800 | V |
| On-State RMS Current (Full Cycle Sine Wave, 50 to 60 H: | $z, T_{c} = 80^{\circ}C)$ | I _{T (RMS)} | 15 | А |
| Peak Non-Repetitive Surge Current (One Full Cycle Sine Non-Repetitive Surge Sine Non-Reptitive S | Nave, 60 Hz, $T_C = 80$ °C) | I _{TSM} | 150 | А |
| Peak Gate Voltage (Pulse Width \leq 1.0 µsec; T _C = 90°C) | V_{GM} | 10 | V | |
| Circuit Fusing Consideration (t = 8.3 ms) | | l²t | 93 | A²sec |
| Peak Gate Power ($T_c = 80^{\circ}\text{C}$, Pulse Width = 1.0 μ s) | | P_{GM} | 20 | W |
| Peak Gate Current (Pulse Width $\leq 1.0 \mu sec; T_c = 90^{\circ}C$) | | I _{GM} | 2.0 | А |
| Average Gate Power (t = 8.3 ms , $T_c = 80^{\circ}\text{C}$) | | P _{G (AV)} | 0.5 | W |
| Operating Junction Temperature Range | | T_{J} | -40 to +125 | °C |
| Storage Temperature Range | T _{stg} | -40 to +150 | °C | |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the

Thermal Characteristics

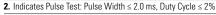
| Rating | | Symbol | Value | Unit |
|--|---|--------------------------------------|-------------|------|
| Thermal Resistance, | Junction-to-Case (AC) Junction-to-Ambient | R _{ejc} R _{eja} | 2.0 62.5 | °C/W |
| Maximum Lead Temperature for Soldering Purpose | s, 1/8" from case for 10 seconds | T _L | 260 | °C |

Electrical Characteristics - OFF (TJ = 25°C unless otherwise noted; Electricals apply in both directions)

| Characteristic | | Symbol | Min | Тур | Max | Unit |
|--|------------------------|--------------------|-----|-----|------|------|
| Peak Repetitive Blocking Current | T ₁ = 25°C | I _{DRM} , | - | - | 0.01 | mΛ |
| $(V_D = V_{DRM} = V_{RRM}; Gate Open)$ | T _J = 125°C | I _{RRM} | - | - | 2.0 | mA |

Electrical Characteristics - ON (TJ = 25°C unless otherwise noted; Electricals apply in both directions)

| Characteristic | | | Min | Тур | Max | Unit |
|---|--------------|-----------------|-----|-----|-----|------|
| Peak On-State Voltage (Note 2) (I _{TM} = ±21 A Peak) | | V_{TM} | - | 1.3 | 1.6 | V |
| 0 . T' 0 | MT2(+), G(+) | | - | - | 50 | |
| Gate Trigger Current (Continuous dc) | MT2(+), G(-) | | - | - | 50 | mA |
| $(V_D = 12 \text{ V}, R_1 = 100 \Omega)$ | MT2(-), G(-) | GT | - | - | 50 | IIIA |
| $(V_D - 12 V, 11_L - 100 \Omega)$ | MT2(-), G(+) | | - | - | 75 | |
| 0 . T: VIII | MT2(+), G(+) | | - | 0.9 | 2 | |
| Gate Trigger Voltage | MT2(+), G(-) | \/ | - | 0.9 | 2 | V |
| (Continuous dc) $(V_D = 12 \text{ V, } R_1 = 100 \Omega)$ | MT2(-), G(-) | V _{GT} | - | 1.1 | 2 | V |
| $(V_D - 12 V, 11_L - 100 \Omega)$ | MT2(-), G(+) | | - | 1.4 | 2.5 | |
| 0 | MT2(+), G(+) | | 0.2 | - | - | |
| Gate Non-Trigger Voltage | MT2(+), G(-) | ., | 0.2 | - | - | .,, |
| $(T_J = 110^{\circ}C)$ $(V_D = 12 \text{ V}, R_1 = 100 \Omega)$ | MT2(-), G(-) | V_{GD} | 0.2 | - | - | V |
| $(V_D - 12 V, H_L - 100 \Omega)$ | MT2(-), G(+) | | 0.2 | - | - | |
| Holding Current ($V_D = 12 V_{dc'}$, Gate Open, Initiating Current = ±200 mA)) | | l _H | - | 6.0 | 40 | mA |
| Turn-On Time (VD = Rated VDRM, ITM = 17 A) (IGT = 120 mA, Rise Time = 0.1 μ s, Pulse Width = 2 μ s) | | tgt | - | 1.5 | - | μs |





Recommended Operating Conditions may affect device reliability.

1. V_{ISBM} and V_{SSBM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

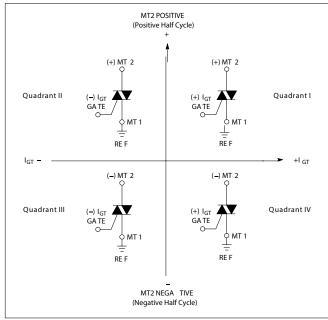
Dynamic Characteristics

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|--------|-----|-----|-----|------|
| Critical Rate of Rise of Commutation Voltage ($V_D = Rated V_{DRM}$, $I_{TM} = 21 A$, Commutating di/dt = 7.6 A/ms, Gate Unenergized, $I_C = 80^{\circ}C$) | dV/dt | _ | 5.0 | _ | V/µs |

Voltage Current Characteristic of SCR

| Symbol | Parameter |
|-----------------------|---|
| V_{DRM} | Peak Repetitive Forward Off State Voltage |
| I _{DRM} | Peak Forward Blocking Current |
| $V_{_{\mathrm{RRM}}}$ | Peak Repetitive Reverse Off State Voltage |
| I _{RRM} | Peak Reverse Blocking Current |
| V_{TM} | Maximum On State Voltage |
| I _H | Holding Current |

Quadrant Definitions for a Triac



All polarities are referenced to MT1.
With in-phase signals (using standard AC lines) quadrants I and III are used

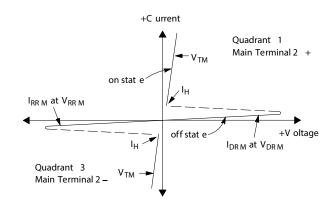


Figure 1. RMS Current Derating

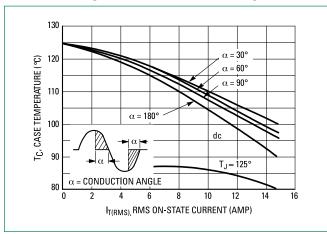


Figure 2. On-State Power Dissipation

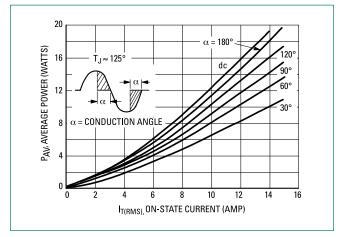


Figure 3. Typical Gate Trigger Voltage

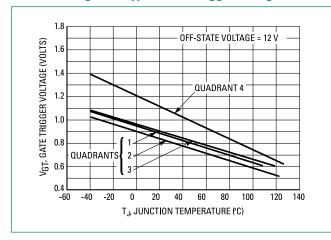


Figure 4. Typical Gate Trigger Current

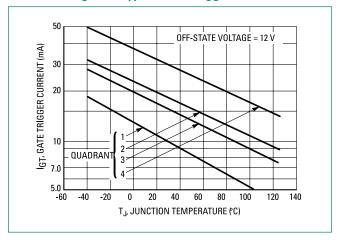




Figure 5. On-State Characteristics

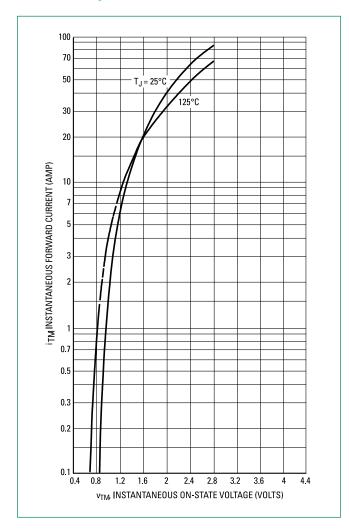


Figure 6. Typical Holding Current

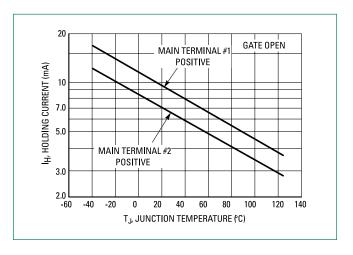


Figure 7. Maximum Non-Repetitive Surge Current

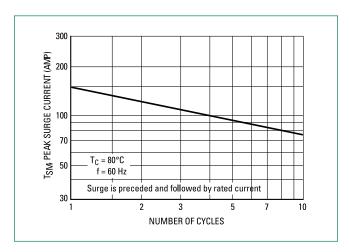
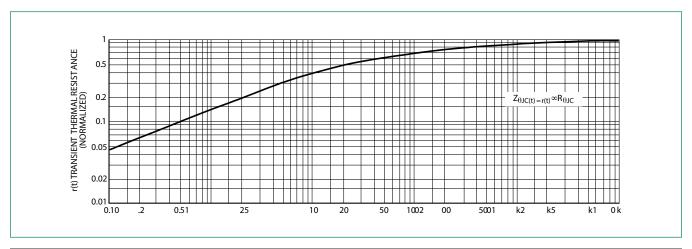


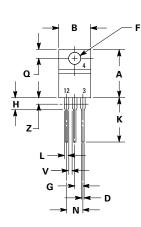
Figure 8. Thermal Response

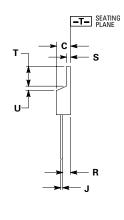




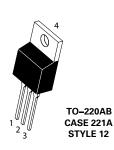
MAC15 Series TRIAC - 400V - 800V

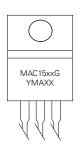
Dimensions





Part Marking System





xx =See Table on Page 2 Y =Year M =Month A =Assembly Site

XX =Lot Serial Code G =Pb-Free Package

| Dim | Inches | | Millin | neters |
|-----|--------|-------|--------|--------|
| ИIM | Min | Max | Min | Max |
| Α | 0.590 | 0.620 | 14.99 | 15.75 |
| В | 0.380 | 0.420 | 9.65 | 10.67 |
| С | 0.178 | 0.188 | 4.52 | 4.78 |
| D | 0.025 | 0.035 | 0.64 | 0.89 |
| F | 0.142 | 0.147 | 3.61 | 3.73 |
| G | 0.095 | 0.105 | 2.41 | 2.67 |
| Н | 0.110 | 0.130 | 2.79 | 3.30 |
| J | 0.018 | 0.024 | 0.46 | 0.61 |
| K | 0.540 | 0.575 | 13.72 | 14.61 |
| L | 0.060 | 0.075 | 1.52 | 1.91 |
| N | 0.195 | 0.205 | 4.95 | 5.21 |
| Q | 0.105 | 0.115 | 2.67 | 2.92 |
| R | 0.085 | 0.095 | 2.16 | 2.41 |
| S | 0.045 | 0.060 | 1.14 | 1.52 |
| T | 0.235 | 0.255 | 5.97 | 6.47 |
| U | 0.000 | 0.050 | 0.00 | 1.27 |
| V | 0.045 | - | 1.15 | - |
| Z | - | 0.080 | - | 2.04 |

| Pin Assignment | | | | |
|----------------|-----------------|--|--|--|
| 1 | Main Terminal 1 | | | |
| 2 | Main Terminal 2 | | | |
| 3 | Gate | | | |
| 4 | Main Terminal 2 | | | |
| | | | | |

Ordering Information

| Device | Device Marking | Package | Shipping |
|-----------|----------------|-----------------------|----------------|
| MAC15-8G | MAC15-8 | | |
| MAC15-10G | MAC1510 | TO 0004D | |
| MAC15A6G | MAC15A6 | TO-220AB (Pb-Free) | 1000 Units/Box |
| MAC15A8G | MAC15A8 | | |
| MAC15A10G | MAC15A10 | | |



^{1.} Dimensioning and tolerancing per ansi y14.5m, 1982.

Controlling dimension: inch.
 Dimension z defines a zone where all body and lead irregularities are allowed.